

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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## Intel® Xeon® Gold 6130T Processor

22M Cache, 2.10 GHz

Spec Code SR3J8

Ordering Code CD8067303593000

## Intel® Xeon® Gold 6130T Processor (22M Cache, 2.10 GHz)

Code Name	Skylake
<u>Essentials</u>	
Vertical Segment	Server
Processor Number	6130T
Status	Launched
Launch Date	Q3'17
Lithography	14 nm
Recommended Customer Price	\$1988.00
<u>Performance</u>	
# of Cores	16
# of Threads	32
Processor Base Frequency	2.10 GHz
Max Turbo Frequency	3.70 GHz
Cache	22 MB L3
# of UPI Links	3
<u>TDP</u>	<u>125 W</u>
Supplemental Information	
Embedded Options Available	Yes
Conflict Free	Yes
Datasheet	Link
Product Brief	Link
Memory Specifications	
Max Memory Size (dependent on memory t	yr 768 GB

Memory Types	DDR4-2666	
Maximum Memory Speed	2.67 GHz	
Max # of Memory Channels	6	
ECC Memory Supported ‡	<u>Yes</u>	
Expansion Options		
Scalability	S4S	
PCI Express Revision	3.0	
Max # of PCI Express Lanes	48	
Package Specifications		
Sockets Supported	FCLGA3647	
T <sub>CASE</sub>	92°C	
Package Size	76.0mm x 56.5mm	
Low Halogen Options Available	See MDDS	
Advanced Technologies		
Intel® Optane™ Memory Supported ‡	No	
Intel® Speed Shift Technology	Yes	
Intel® Turbo Boost Max Technology 3.0 ‡	No	
Intel® Turbo Boost Technology	2.0	
Intel® vPro™ Technology ‡	Yes	
Intel® Hyper-Threading Technology ‡	Yes	
Intel® Virtualization Technology (VT-x) ‡	Yes	
Intel® TSX-NI	Yes	
Intel® 64 ‡	Yes	
Instruction Set Extensions	Intel® SSE4.2, Intel® AVX, Intel® AVX2, Intel® AVX-512	
# of AVX-512 FMA Units	2	
Intel® Volume Management Device (VMD)	<u>Yes</u>	
Security & Reliability		
Intel® AES New Instructions	Yes	
Intel® Trusted Execution Technology ‡	Yes	
Intel® Run Sure Technology	Yes	
Mode-based Execute Control (MBE)	Yes	